

Application Serial No. 10/626,908
Reply to Office Action of January 14, 2008

PATENT
Docket: CU-5972

Amendments to the Claims

The listing of claims presented below replaces all prior versions, and listings, of claims in the application.

Listing of claims:

1. (Previously Presented) A volume hologram transfer foil comprising a substrate, a volume hologram layer formed on the substrate and a heat sensitive adhesive layer formed on the volume hologram layer,
wherein the volume hologram layer has a breaking strain at 25° in range of 0.5% to 15%, breaking strain at 120°C in a range of 0.5% to 30%,
the heat sensitive adhesive layer has a breaking strain at 25°C in range of 0.5% to 15%, and
a difference in the breaking strain 25°C between the volume hologram layer and the heat sensitive adhesive layer is 7.5% or less.
2. (Original) The volume hologram transfer foil according to Claim 1, wherein the heat sensitive adhesive layer contains a fine particle.
- 3-6. (Cancelled)
7. (Original) The volume hologram transfer foil according to Claim 2, wherein the fine particle is an organic fine particle having thermoplasticity and having a glass transition temperature of 120°C or higher.
8. (Cancelled)
9. (Original) The volume hologram transfer foil according to Claim 2, wherein the fine particle is resin bead pigment.
10. (Cancelled)
11. (Original) The volume hologram transfer foil according to Claim 2, wherein the fine particle is a fluorescent fine particle.

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12. (Cancelled)

13. (Original) The volume hologram transfer foil according to Claim 1, wherein a delaminating layer is provided in between the substrate and the volume hologram layer, is provided in between the substrate and the volume hologram layer.

14. (Cancelled)